

Universal Operational Amplifier Evaluation Module Selection Guide

The universal operational amplifier evaluation module is a printed-circuit board (PCB) that greatly reduces design time, intended for quick evaluation of amplifiers. See respective data books for audio power or high-speed amplifier EVMs. The purpose of this guide is to help select the appropriate EVM based on specific amplifier package requirements.

	Shutdown	Package	OPAMPEVM-SOT23 [†]	OPAMPEVM-SOT23SHDN [‡]	OPAMPEVM-MSOPTSSOP [§]	OPAMPEVM-SOIC [¶]	OPAMPEVM-PDIP [#]
SINGLE	Without Shutdown	PDIP					X (8-pin)
		SOIC				X (8-pin)	
		SOT-23	X (5-pin)				
		TSSOP					
		MSOP			X (8-pin)		
	With Shutdown	PDIP					X (8-pin)
		SOIC		X (8-pin)		X (8-pin)	
		SOT-23		X (6-pin)			
		TSSOP					
		MSOP			X (8-pin)		
DUAL	Without Shutdown	PDIP					X (8-pin)
		SOIC	X (8-pin)			X (8-pin)	
		SOT-23					
		TSSOP					
		MSOP	X (8-pin)				
	With Shutdown	PDIP					X (14-pin)
		SOIC		X (14-pin)		X (14-pin)	
		SOT-23					
		TSSOP					
		MSOP		X (10-pin)	X (10-pin)		
QUAD	Without Shutdown	PDIP					X (14-pin)
		SOIC				X (14-pin)	
		SOT-23					
		TSSOP			X (14-pin)		
		MSOP					
	With Shutdown	PDIP					X (16-pin)
		SOIC				X (16-pin)	
		SOT-23					
		TSSOP			X (16-pin)		
		MSOP					

Universal operational amplifier EVMs are compatible with hundreds of TI amplifier samples. Samples are available by selecting the *Pricing/Samples/Availability* option from each individual amplifier web product folder.

DO NOT FORGET TO ORDER SAMPLES!

PowerPAD is a trademark of Texas Instruments.

[†] EVM Manual (SLVU006), also accommodates SOIC and MSOP packages

[‡] EVM Manual (SLVU009), also accommodates SOIC and MSOP packages with shutdown

[§] EVM Manual (SLOU055), this EVM accommodates MSOP and TSSOP packaging with or without PowerPAD™

[¶] EVM Manual (SLOU061)

[#] EVM Manual (SLOU062)

SLOU060B

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